FAIRCHILD SEMICONDUCTOR®

March 2013

FGA20S120M

1200 V, 20 A Shorted-anode IGBT

Features

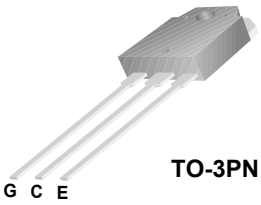
- High Speed Switching
- Low Saturation Voltage: $V_{CE(sat)}$ = 1.55 V @ I_C = 20 A
- High Input Impedance
- RoHS Compliant

Applications

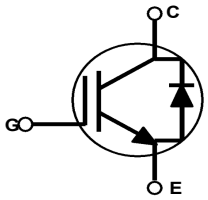
- Induction Heating, Microwave Oven

General Description

Using advanced field stop trench and shorted-anode technology, Fairchild®'s shorted-anode trench IGBTs offer superior conduction and switching performances for soft switching applications. The device can operate in parallel configuration with exceptional avalanche capability. This device is designed for induction heating and microwave oven.



TO-3PN



Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Description		Ratings	Unit
V_{CES}	Collector to Emitter Voltage		1200	V
V_{GES}	Gate to Emitter Voltage		±25	V
I_C	Collector Current	@ T_C = 25°C	40	A
	Collector Current	@ T_C = 100°C	20	A
$I_{CM\ (1)}$	Pulsed Collector Current		60	A
I_F	Diode Continuous Forward Current	@ T_C = 25°C	40	A
I_F	Diode Continuous Forward Current	@ T_C = 100°C	20	A
P_D	Maximum Power Dissipation	@ T_C = 25°C	348	W
	Maximum Power Dissipation	@ T_C = 100°C	174	W
T_J	Operating Junction Temperature		-55 to +175	°C
T_{stg}	Storage Temperature Range		-55 to +175	°C
T_L	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seconds		300	°C

Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JC}$(IGBT)	Thermal Resistance, Junction to Case	--	0.43	°C/W
$R_{\theta JC}$(Diode)	Thermal Resistance, Junction to Case	--	0.43	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	--	40	°C/W

Notes:
1: Limited by Tjmax

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Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FGA20S120M	FGA20S120M	TO-3PN	-	-	30

Electrical Characteristics of the IGBT T_C = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Off Characteristics						
BV_{CES}	Collector to Emitter Breakdown Voltage	V_{GE} = 0V, I_C = 2mA	1200	-	-	V
I_{CES}	Collector Cut-Off Current	V_{CE} = V_{CES}, V_{GE} = 0V	-	-	1	mA
I_{GES}	G-E Leakage Current	V_{GE} = V_{GES}, V_{CE} = 0V	-	-	±250	nA
On Characteristics						
$V_{GE(th)}$	G-E Threshold Voltage	I_C = 20mA, V_{CE} = V_{GE}	4.5	6.0	7.5	V
$V_{CE(sat)}$	Collector to Emitter Saturation Voltage	I_C = 20A, V_{GE} = 15V, T_C = 25°C	-	1.55	1.85	V
		I_C = 20A, V_{GE} = 15V, T_C = 125°C	-	1.75	-	V
		I_C = 20A, V_{GE} = 15V, T_C = 175°C	-	1.85	-	V
V_{FM}	Diode Forward Voltage	I_F = 20A, T_C = 25°C	--	1.7	2.2	V
		I_F = 20A, T_C = 175°C	--	2.1	-	V
Dynamic Characteristics						
C_{ies}	Input Capacitance	V_{CE} = 30V, V_{GE} = 0V, f = 1MHz	--	2680	--	pF
C_{oes}	Output Capacitance		--	53	--	pF
C_{res}	Reverse Transfer Capacitance		--	43	--	pF
Switching Characcteristics						
$t_{d(on)}$	Turn-On Delay Time	V_{CC} = 600V, I_C = 20A, R_G = 10Ω, V_{GE} = 15V, Resistive Load, T_C = 25°C	-	43	-	ns
t_r	Rise Time		-	176	-	ns
$t_{d(off)}$	Turn-Off Delay Time		-	310	-	ns
t_f	Fall Time		-	320	480	ns
E_{on}	Turn-On Switching Loss		-	0.52	-	mJ
E_{off}	Turn-Off Switching Loss		-	1.43	2.15	mJ
E_{ts}	Total Switching Loss		-	1.95	-	mJ
$t_{d(on)}$	Turn-On Delay Time	V_{CC} = 600V, I_C = 20A, R_G = 10Ω, V_{GE} = 15V, Resistive Load, T_C = 175°C	-	41	-	ns
t_r	Rise Time		-	260	-	ns
$t_{d(off)}$	Turn-Off Delay Time		-	345	-	ns
t_f	Fall Time		-	520	-	ns
E_{on}	Turn-On Switching Loss		-	0.78	-	mJ
E_{off}	Turn-Off Switching Loss		-	1.97	-	mJ
E_{ts}	Total Switching Loss		-	2.75	-	mJ
Q_g	Total Gate Charge	V_{CE} = 600V, I_C = 20A, V_{GE} = 15V	-	208	-	nC
Q_{ge}	Gate to Emitter Charge		-	18	-	nC
Q_{gc}	Gate to Collector Charge		-	119	-	nC

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Typical Performance Characteristics

Figure 1. Typical Output Characteristics

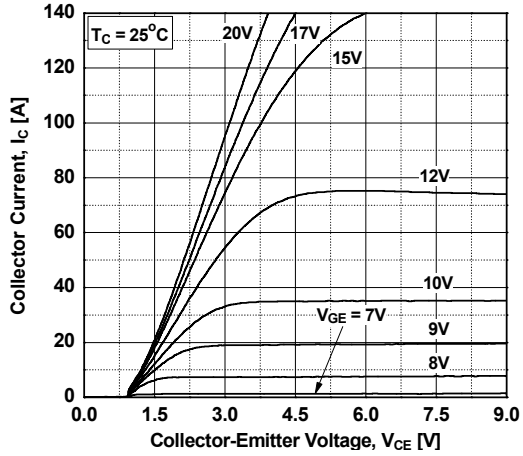


Figure 2. Typical Output Characteristics

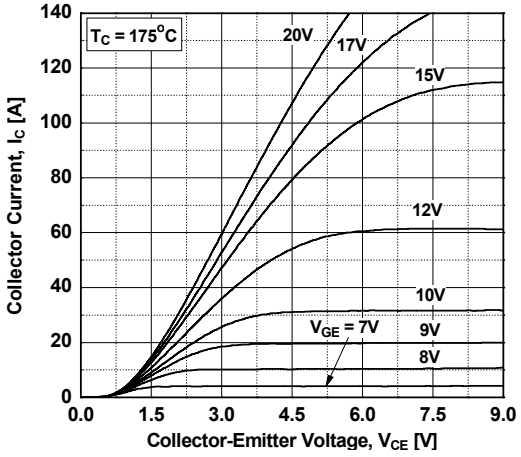


Figure 3. Typical Saturation Voltage Characteristics

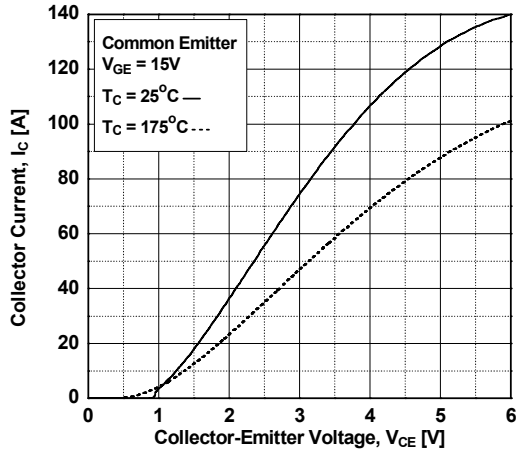


Figure 4. Transfer Characteristics

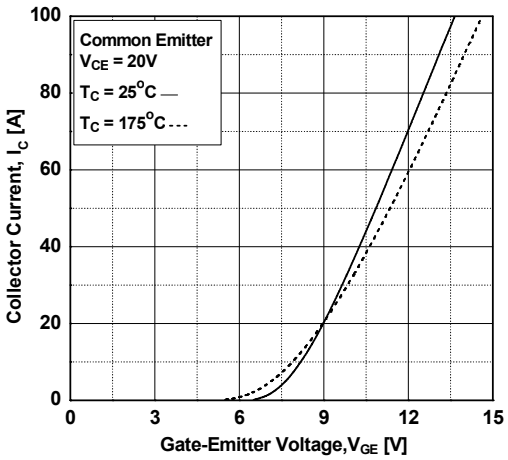


Figure 5. Saturation Voltage vs. Case Temperature at Variant Current Level

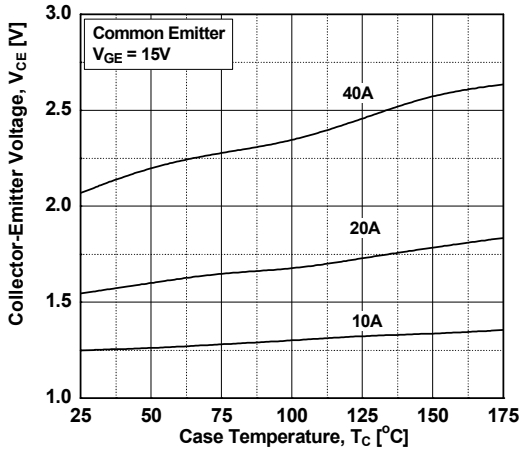
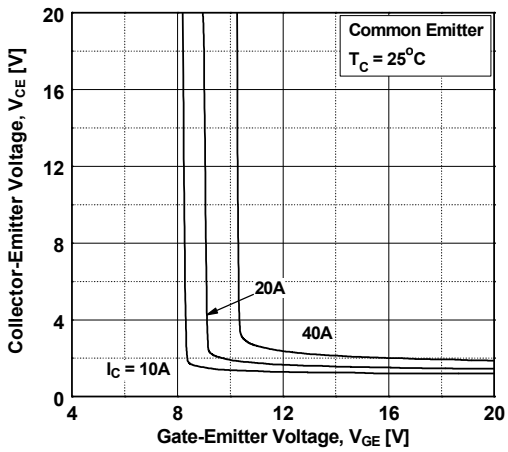


Figure 6. Saturation Voltage vs. V_{GE}



Typical Performance Characteristics

Figure 7. Saturation Voltage vs. V_{GE}

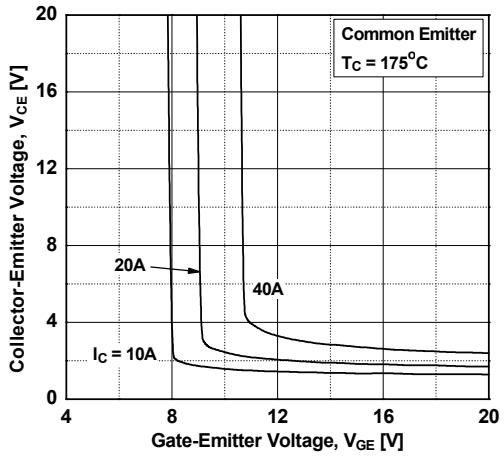


Figure 8. Capacitance Characteristics

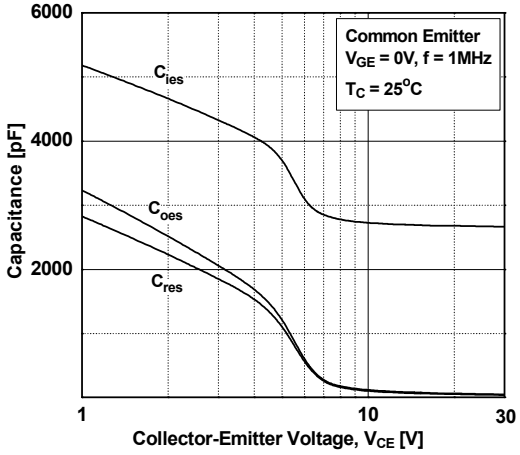


Figure 9. Gate Charge Characteristics

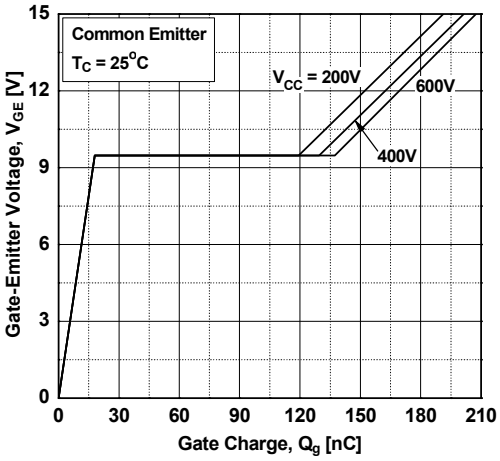


Figure 10. SOA Characteristics

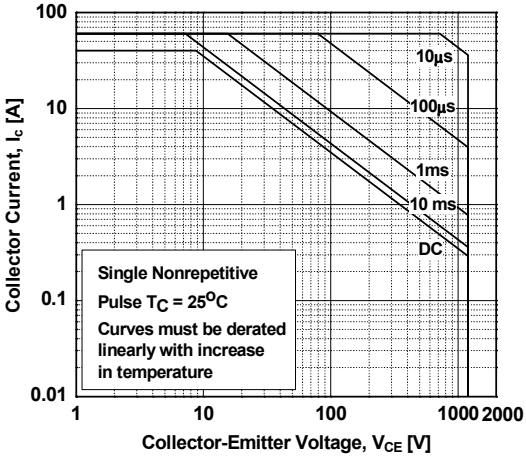


Figure 11. Turn-On Characteristics vs. Gate Resistance

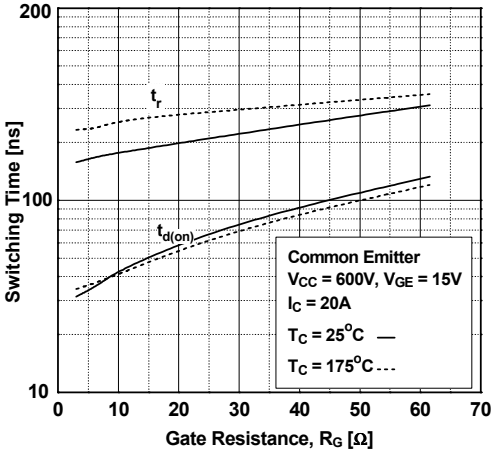
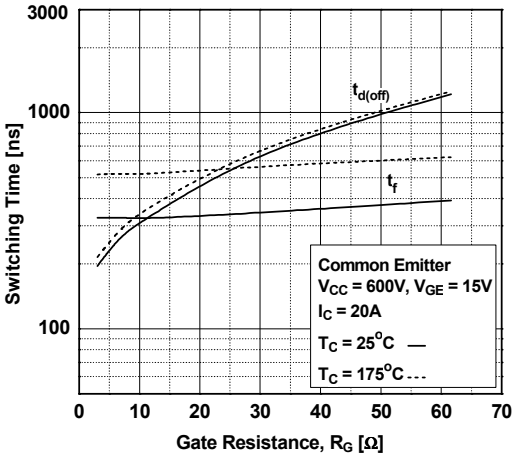


Figure 12. Turn-Off Characteristics vs. Gate Resistance



Typical Performance Characteristics

Figure 13. Turn-On Characteristics vs. Collector Current

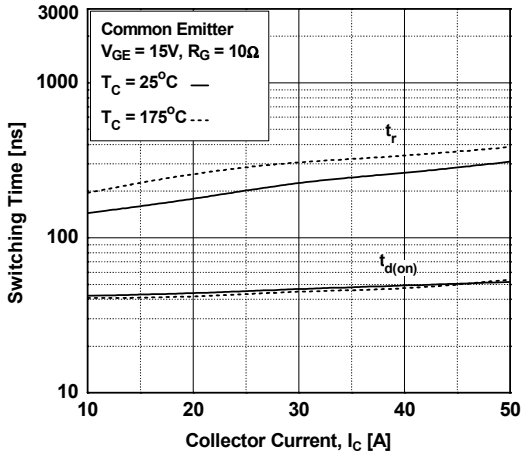


Figure 14. Turn-off Characteristics vs. Collector Current

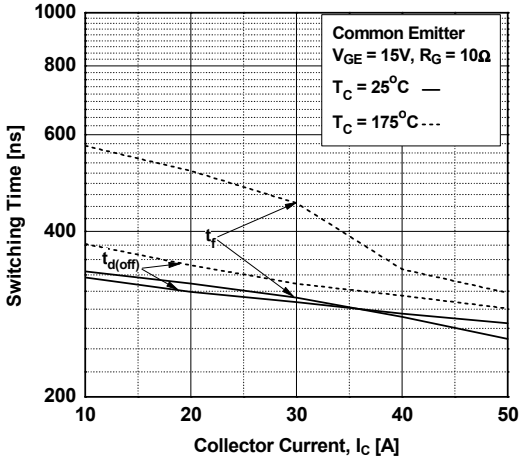


Figure 15. Switching Loss vs. Gate resistance

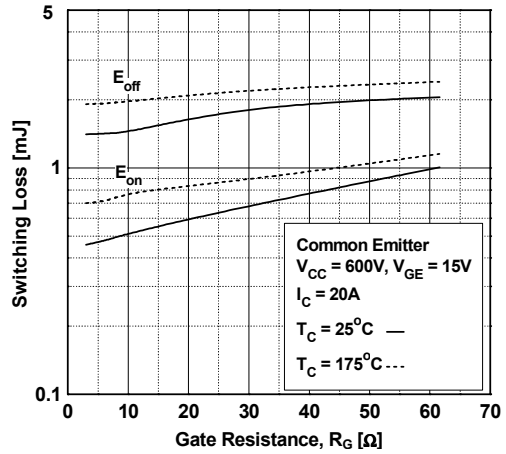


Figure 16. Switching Loss vs. Collector Current

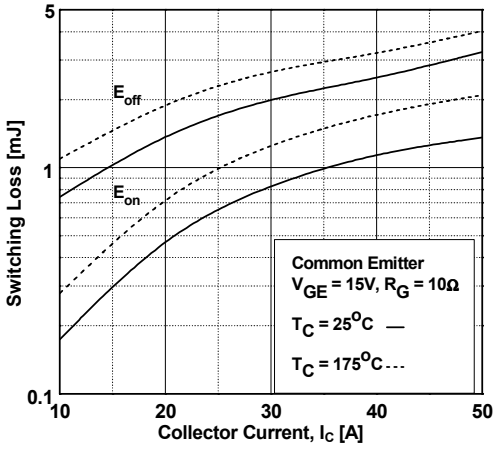


Figure 17. Turn-Off Switching SOA Characteristics Collector Currrent

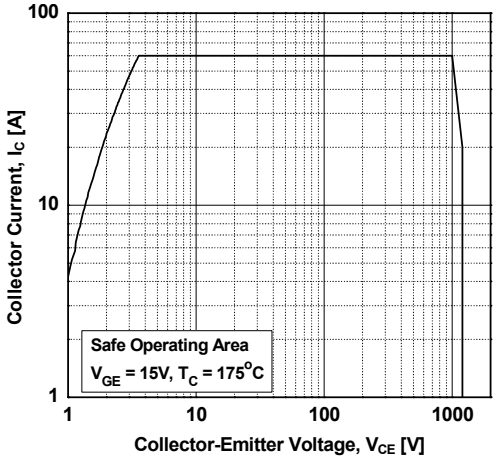


Figure 18. Diode Forward Characteristics

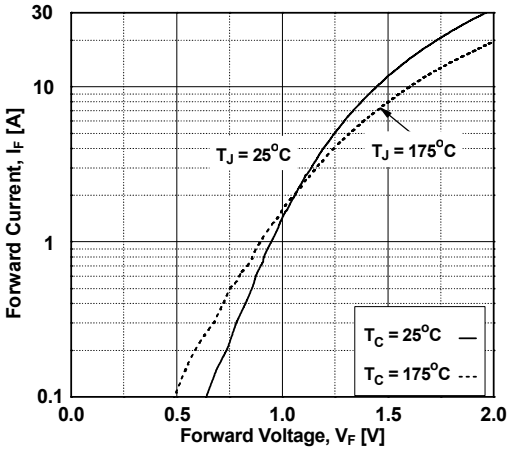
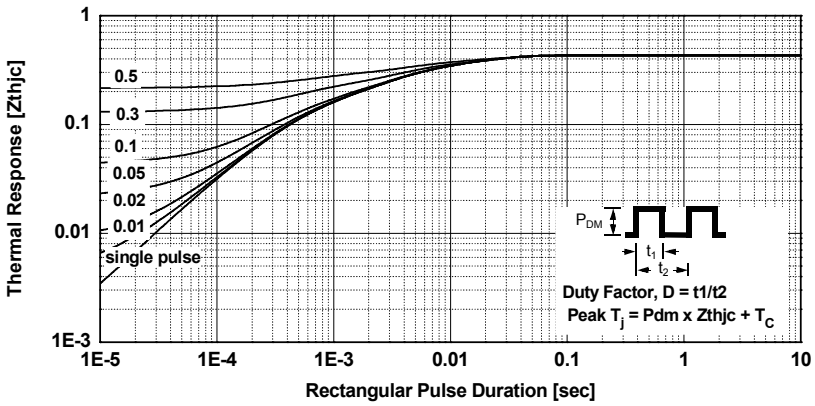
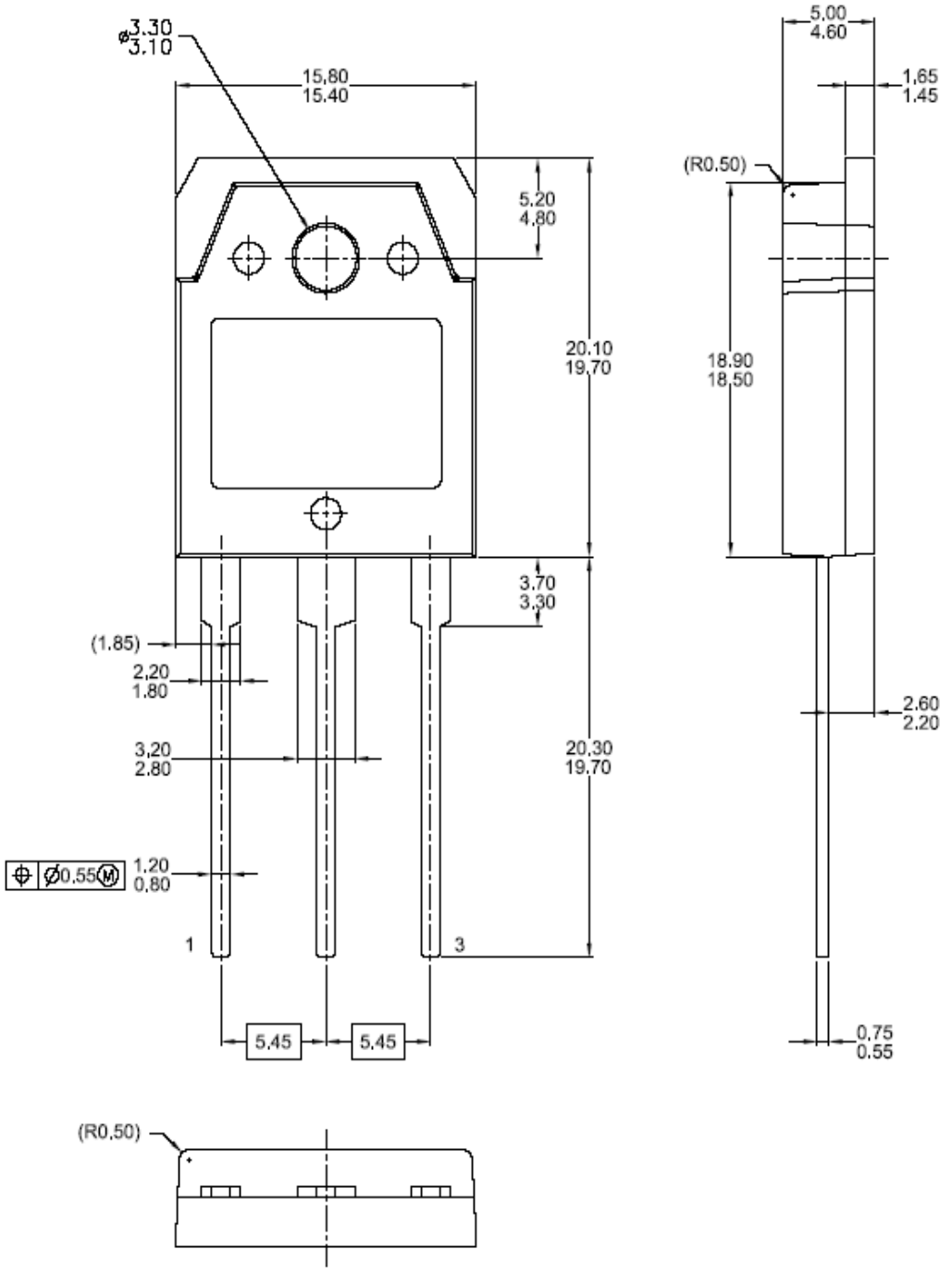


Figure 19. Transient Thermal Impedeance of IGBT



Mechanical Dimensions

TO-3PN



Dimensions in Millimeters

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No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

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